

ABSTRACT OF THE DISCLOSURE

This invention discloses a solderability testing apparatus which comprises a sample parts holding means having a sample parts holding member for holding a sample; an external force 5 detection means for supporting such sample parts holding means; a solder paste container for containing a solder paste which is internally added with a flux; and a heating means for heating the solder paste; wherein such apparatus has a flux wetting preventive layer at least on the surface of a sample holding 10 portion of the sample parts holding member.

20250313-00001